



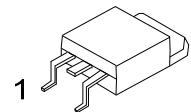
UTD413

Power MOSFET

P-CHANNEL
ENHANCEMENT MODE

■ DESCRIPTION

The **UTD413** can provide excellent $R_{DS(ON)}$ and low gate charge by using UTC's advanced trench technology. The **UTD413** is well suited for high current load applications with the excellent thermal resistance of the TO-252 package. Standard Product **UTD413** is Pb-free.



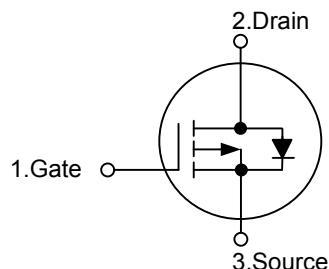
TO-252

■ FEATURES

- * $R_{DS(ON)} < 45m\Omega$ @ $V_{GS} = -10V$
- * $R_{DS(ON)} < 69m\Omega$ @ $V_{GS} = -4.5V$
- * Low capacitance
- * Low gate charge
- * Fast switching capability
- * Avalanche energy specified

Lead-free: UTD413L
Halogen-free: UTD413G

■ SYMBOL



■ ORDERING INFORMATION

| Ordering Number | | | Package | Pin Assignment | | | Packing |
|-----------------|---------------|---------------|---------|----------------|---|---|-----------|
| Normal | Lead Free | Halogen Free | | 1 | 2 | 3 | |
| UTD413-TN3-R | UTD413L-TN3-R | UTD413G-TN3-R | TO-252 | G | D | S | Tape Reel |
| UTD413-TN3-T | UTD413L-TN3-T | UTD413G-TN3-T | TO-252 | G | D | S | Tube |

| | | |
|---------------|---|--|
| UTD413L-TN3-R | (1)Packing Type (2)Package Type (3)Lead Plating | (1) R: Tape Reel, T: Tube (2) TN3: TO-252 (3) G: Halogen Free, L: Lead Free, Blank: Pb/Sn |
|---------------|---|--|

■ ABSOLUTE MAXIMUM RATINGS ($T = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | RATINGS | UNIT |
|--|-----------|------------|------------------|
| Drain-Source Voltage | V_{DSS} | -40 | V |
| Gate-Source Voltage | V_{GSS} | ± 20 | V |
| Continuous Drain Current | I_D | -12 | A |
| Pulsed Drain Current | I_{DM} | -30 | A |
| Avalanche Current | I_{AR} | -12 | A |
| Repetitive avalanche energy $L=0.1\text{mH}$ | E_{AR} | 30 | mJ |
| Power Dissipation | P_D | 2.5 | W |
| Junction Temperature | T_J | +175 | $^\circ\text{C}$ |
| Storage Temperature | T_{STG} | -55 ~ +175 | $^\circ\text{C}$ |

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by $T_{J(\text{MAX})}$

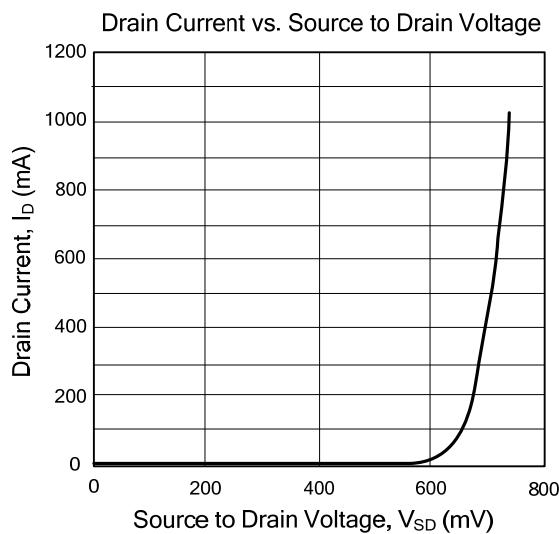
■ THERMAL CHARACTERISTICS

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNIT |
|---------------------|---------------|-----|-----|-----|---------------------------|
| Junction-to-Ambient | θ_{JA} | | 40 | 50 | $^\circ\text{C}/\text{W}$ |
| Junction-to-Case | θ_{JC} | | 2.5 | 3 | $^\circ\text{C}/\text{W}$ |

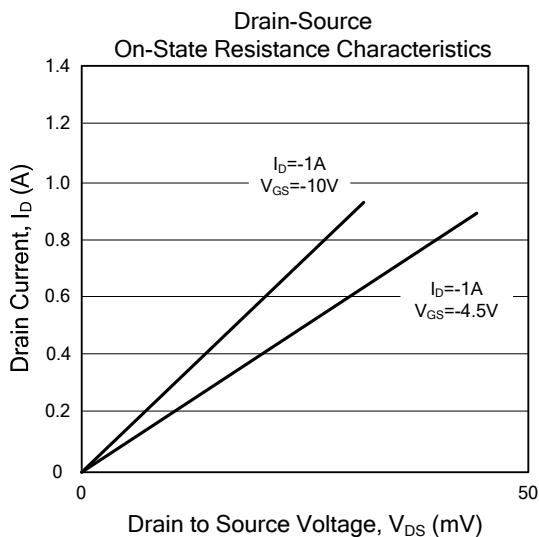
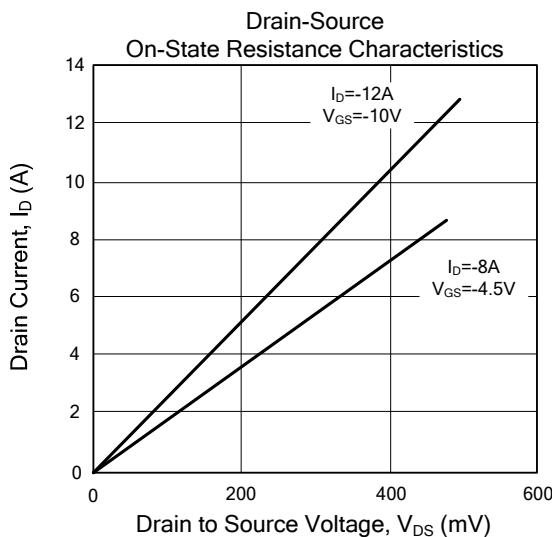
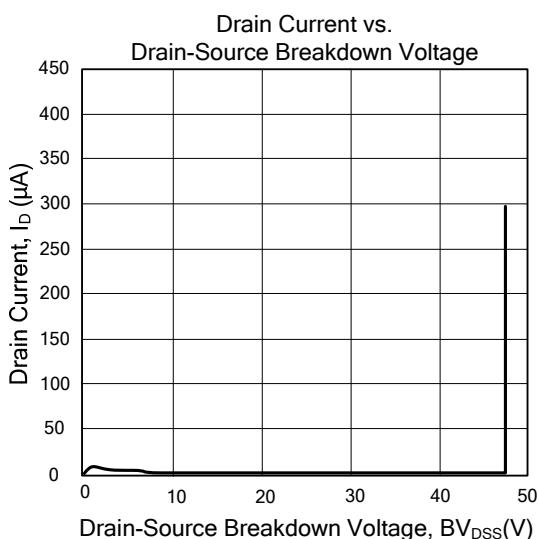
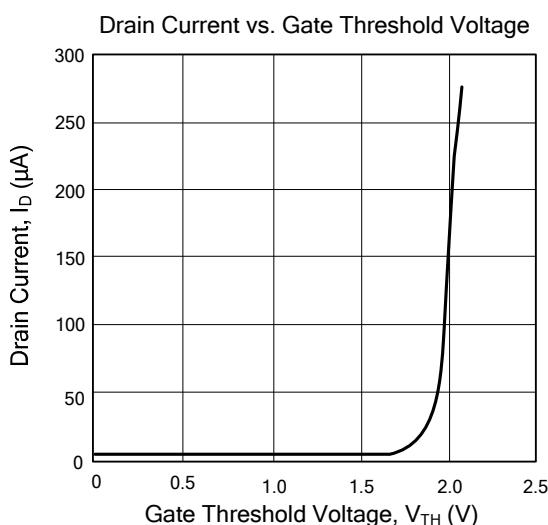
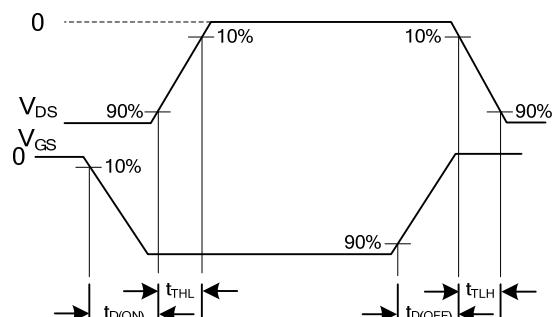
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---------------------|--|--|-------|-----------|------------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0\text{V}, I_D=-10\text{mA}$ | -40 | | | V |
| Drain-Source Leakage Current | I_{DSS} | $V_{DS}=-32\text{V}, V_{GS}=0\text{V}$ | | | -1 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$ | | | ± 100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | $V_{GS(\text{TH})}$ | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | -1 | -1.9 | -3 | V |
| On State Drain Current | $I_{D(\text{ON})}$ | $V_{DS}=-5\text{V}, V_{GS}=-10\text{V}$ | -30 | | | A |
| Static Drain-Source On-Resistance | $R_{DS(\text{ON})}$ | $V_{GS}=-10\text{V}, I_D=-12\text{A}$ $V_{GS}=-4.5\text{V}, I_D=-8\text{A}$ | | 36 | 45 | $\text{m}\Omega$ |
| DYNAMIC PARAMETERS | | | | | | |
| Input Capacitance | C_{ISS} | $V_{DS}=-20\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$ | | 657 | | pF |
| Output Capacitance | C_{OSS} | | | 143 | | pF |
| Reverse Transfer Capacitance | C_{RSS} | | | 63 | | pF |
| SWITCHING PARAMETERS | | | | | | |
| Total Gate Charge | 10V 4.5V | Q_G | $V_{DS}=-20\text{V}, V_{GS}=-10\text{V}, I_D=-12\text{A}$ | 14.1 | | nC |
| Gate Source Charge | | Q_{GS} | | 7 | | |
| Gate Drain Charge | | Q_{GD} | | 2.2 | | nC |
| Turn-ON Delay Time | $t_{D(\text{ON})}$ | | $V_{GS}=-10\text{V}, V_{DS}=-20\text{V}, R_L=1.7\Omega, R_G=3\Omega$ | 4.1 | | nC |
| Turn-ON Rise Time | t_R | | | 8 | | ns |
| Turn-OFF Delay Time | $t_{D(\text{OFF})}$ | | | 12.2 | | ns |
| Turn-OFF Fall-Time | t_F | | | 24 | | ns |
| | | | | 12.5 | | ns |
| SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS | | | | | | |
| Diode Forward Voltage | V_{SD} | $I_S=-1\text{A}, V_{GS}=0\text{V}$ | | -0.75 | -1 | V |
| Maximum Body-Diode Continuous Current | I_S | | | | -12 | A |
| Body Diode Reverse Recovery Time | t_{RR} | $I_F=-12\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 23.2 | | ns |
| Body Diode Reverse Recovery Charge | Q_{RR} | $I_F=-12\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 18.2 | | nC |

■ TYPICAL CHARACTERISTICS



Switching Time Waveforms



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